FEATURES:

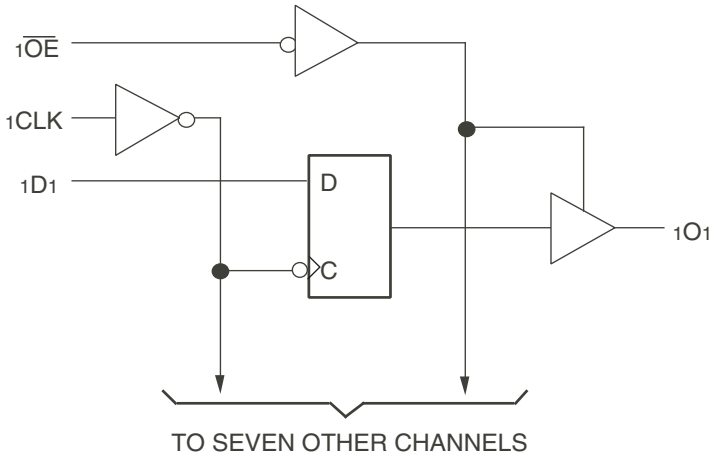
- **0.5 MICRON CMOS Technology**
- **High-speed, low-power CMOS replacement for ABT functions**
- **Typical $t_{SK(o)}$ (Output Skew) < 250ps**
- **Low input and output leakage ≤1µA (max.)**
- **ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)**
- **V_{CC} = 5V ±10%**
- **High drive outputs (–32mA I_{OH}, 64mA I_{OL})**
- **Power off disable outputs permit "live insertion"**
- **Typical V_{OLP} (Output Ground Bounce) < 1.0V at V_{CC} = 5V, T_A = 25°C**
- **Available in the following packages:**
  - *Industrial: SSOP, TSSOP*

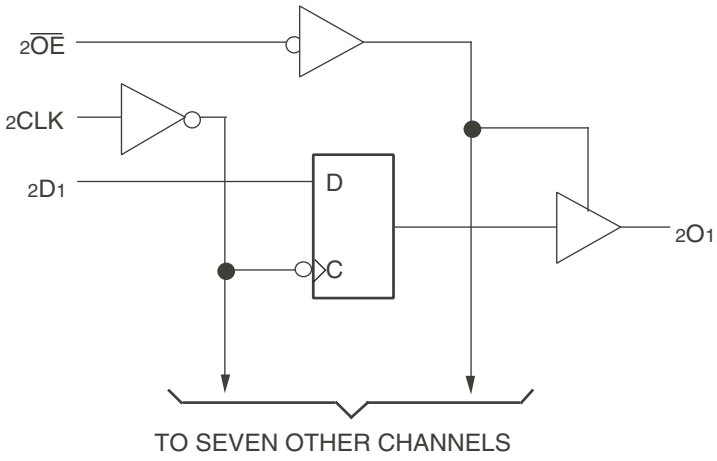
DESCRIPTION:

The FCT16374T 16-bit edge-triggered D-type register is built using advanced dual metal CMOS technology. These high-speed, low-power registers are ideal for use as buffer registers for data synchronization and storage. The Output Enable ($\overline{xOE}$) and clock (xCLK) controls are organized to operate each device as two 8-bit registers or one 16-bit register with common clock. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

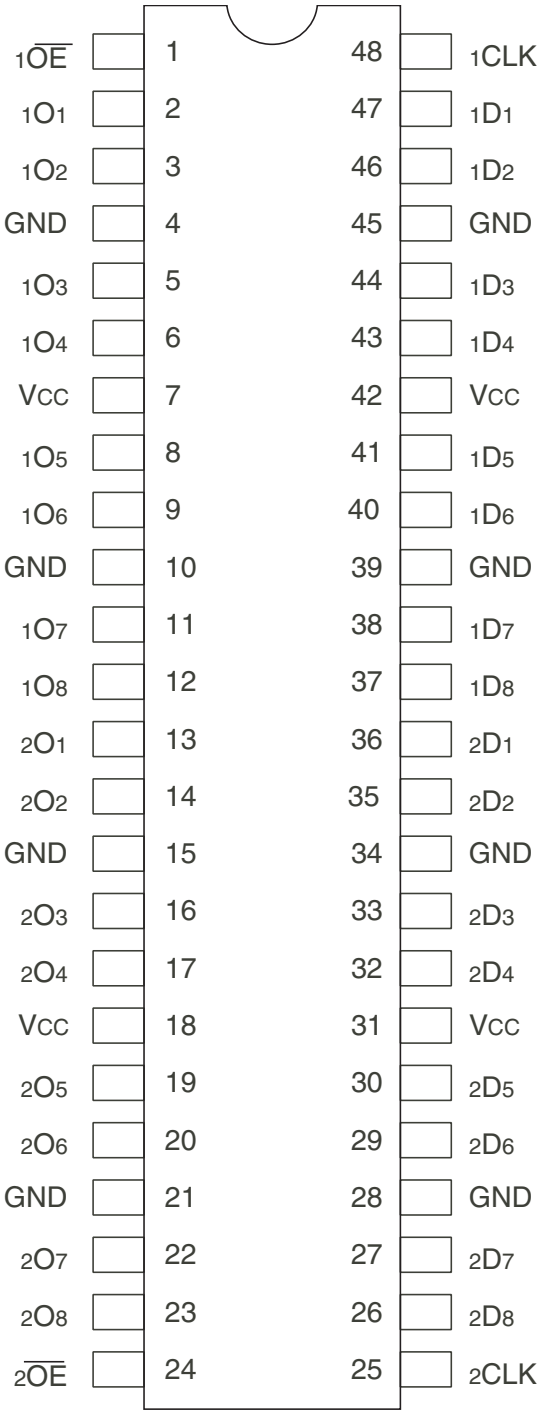
The FCT16374T is ideally suited for driving high-capacitance loads and low-impedance backplanes. The output buffers are designed with power off disable capability to allow "live insertion" of boards when used as backplane drivers.

FUNCTIONAL BLOCK DIAGRAM





PIN CONFIGURATION



TOP VIEW

Package Type	Package Code	Order Code
TSSOP	PAG48	PAG
SSOP	PVG48	PVG

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max	Unit
V_{TERM}(2)	Terminal Voltage with Respect to GND	–0.5 to 7	V
V_{TERM}(3)	Terminal Voltage with Respect to GND	–0.5 to V_{CC}+0.5	V
T_{STG}	Storage Temperature	–65 to +150	°C
I_{OUT}	DC Output Current	–60 to +120	mA

NOTES:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. All device terminals except FCT162XXX Output and I/O terminals.
3. Outputs and I/O terminals for FCT162XXX.

CAPACITANCE (T_A = +25°C, f = 1.0MHz)

Symbol	Parameter(1)	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	3.5	6	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	3.5	8	pF

NOTE:
1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description
xDx	Data Inputs
xCLK	Clock Inputs
xOx	3-State Outputs
x$\overline{OE}$	3-State Output Enable Input (Active LOW)

FUNCTION TABLE(1)

	Inputs			Outputs
Function	xDx	xCLK	x$\overline{OE}$	xOx
Z	X	L	H	Z
	X	H	H	Z
Load Register	L	↑	L	L
	H	↑	L	H
	L	↑	H	Z
	H	↑	H	Z

NOTE:
1. H = HIGH voltage level
   L = LOW voltage level
   X = Don't care
   Z = High-impedance
   ↑ = LOW-to-HIGH transition

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Industrial: T_A = –40°C to +85°C, V_{CC} = 5.0V ±10%

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
V_{IH}	Input HIGH Level	Guaranteed Logic HIGH Level		2	—	—	V
V_{IL}	Input LOW Level	Guaranteed Logic LOW Level		—	—	0.8	V
I_{IH}	Input HIGH Current (Input pins)[5]	V_{CC} = Max.	V_I = V_{CC}	—	—	±1	µA
	Input HIGH Current (I/O pins)[5]			—	—	±1	
I_{IL}	Input LOW Current (Input pins)[5]		V_I = GND	—	—	±1	
	Input LOW Current (I/O pins)[5]			—	—	±1	
I_{OZH}	High Impedance Output Current	V_{CC} = Max.	V_O = 2.7V	—	—	±1	µA
I_{OZL}	(3-State Output pins)[5]		V_O = 0.5V	—	—	±1	
V_{IK}	Clamp Diode Voltage	V_{CC} = Min., I_{IN} = –18mA		—	–0.7	–1.2	V
I_{OS}	Short Circuit Current	V_{CC} = Max., V_O = GND[3]		–80	–140	–250	mA
V_H	Input Hysteresis	—		—	100	—	mV
I_{CCL}	Quiescent Power Supply Current	V_{CC} = Max		—	5	500	µA
I_{CCH}		V_{IN} = GND or V_{CC}					
I_{CCZ}							

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
I_O	Output Drive Current	V_{CC} = Max., V_O = 2.5V[3]		–50	—	–180	mA
V_{OH}	Output HIGH Voltage	V_{CC} = Min.	I_{OH} = –3mA	2.5	3.5	—	V
		V_{CC} = Min.	I_{OH} = –15mA IND	2.4	3.5	—	V
			I_{OH} = –32mA IND	2	3	—	V
V_{OL}	Output LOW Voltage	V_{CC} = Min.	I_{OL} = 64mA IND	—	0.2	0.55	V
		V_{IN} = V_{IH} or V_{IL}					
I_{OFF}	Input/Output Power Off Leakage[5]	V_{CC} = 0V, V_{IN} = or $V_O \leq$ 4.5V		—	—	±1	µA

NOTES:
1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
4. Duration of the condition can not exceed one second.
5. This test limit for this parameter is ±5µA at T_A = –55°C.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
ΔI_{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V_{CC} = Max. V_{IN} = 3.4V[3]		—	0.5	1.5	mA
I_{CCD}	Dynamic Power Supply Current[4]	V_{CC} = Max. Outputs Open x$\overline{OE}$ = GND One Input Toggling 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND	—	60	100	µA/ MHz
I_C	Total Power Supply Current[6]	V_{CC} = Max. Outputs Open f_{CP} = 10MHz 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND	—	0.6	1.5	mA
		x$\overline{OE}$ = GND f_i = 5MHz 50% Duty Cycle One Bit Toggling	V_{IN} = 3.4V V_{IN} = GND	—	1.1	3	
		V_{CC} = Max. Outputs Open f_{CP} = 10MHz 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND	—	3	5.5[5]	
		x$\overline{OE}$ = GND Sixteen Bits Toggling f_i = 2.5MHz 50% Duty Cycle	V_{IN} = 3.4V V_{IN} = GND	—	7.5	19[5]	

NOTES:
1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Per TTL driven input (V_{IN} = 3.4V). All other inputs at V_{CC} or GND.
4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
5. Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
6. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
   $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP} N_{CP}/2 + f_i N_i)$
   I_{CC} = Quiescent Current (I_{CCL}, I_{CCH} and I_{CCZ})
   ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
   D_H = Duty Cycle for TTL Inputs High
   N_T = Number of TTL Inputs at D_H
   I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
   f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
   N_{CP} = Number of Clock Inputs at f_{CP}
   f_i = Input Frequency
   N_i = Number of Inputs at f_i

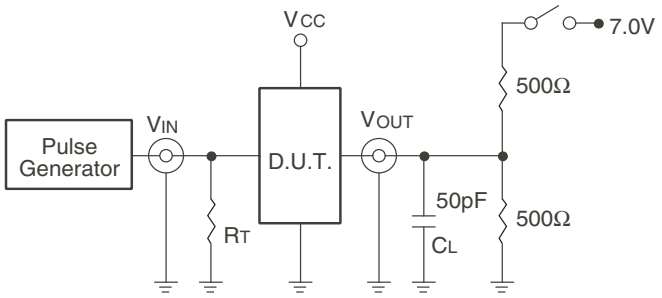
SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	Condition[2]	74FCT16374AT Ind. Min.[2]	74FCT16374AT Ind. Max.	Unit
t_{PLH} t_{PHL}	Propagation Delay xCLK to xOx	C_L = 50pF R_L = 500Ω	2	6.5	ns
t_{PZH} t_{PZL}	Output Enable Time		1.5	6.5	ns
t_{PHZ} t_{PLZ}	Output Disable Time		1.5	5.5	ns
t_{SU}	Set-up Time HIGH or LOW, xDx to xCLK		2	—	ns
t_H	Hold Time HIGH or LOW, xDx to xCLK		1.5	—	ns
t_W	xCLK Pulse Width HIGH or LOW		5	—	ns
$t_{SK(o)}$	Output Skew[3]		—	0.5	ns

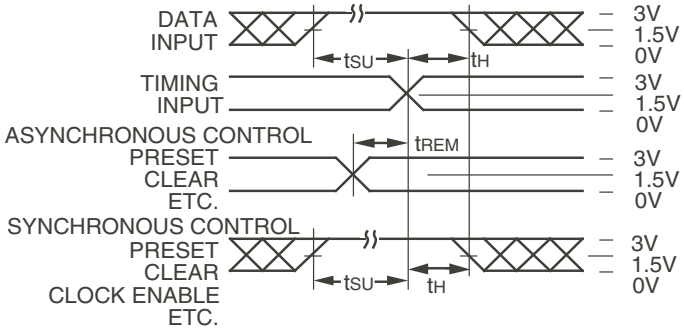
Symbol	Parameter	Condition[2]	74FCT16374CT Ind. Min.[2]	74FCT16374CT Ind. Max.	74FCT16374ET Ind. Min.[2]	74FCT16374ET Ind. Max.	Unit
t_{PLH} t_{PHL}	Propagation Delay xCLK to xOx	C_L = 50pF R_L = 500Ω	2	5.2	1.5	3.7	ns
t_{PZH} t_{PZL}	Output Enable Time		1.5	5.5	1.5	4.4	ns
t_{PHZ} t_{PLZ}	Output Disable Time		1.5	5	1.5	3.6	ns
t_{SU}	Set-up Time HIGH or LOW, xDx to xCLK		2	—	1.5	—	ns
t_H	Hold Time HIGH or LOW, xDx to xCLK		1.5	—	0	—	ns
t_W	xCLK Pulse Width HIGH or LOW		5	—	3[4]	—	ns
$t_{SK(o)}$	Output Skew[3]		—	0.5	—	0.5	ns

NOTES:
1. See test circuit and waveforms.
2. Minimum limits are guaranteed but not tested.
3. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.
4. This limit is guaranteed but not tested.

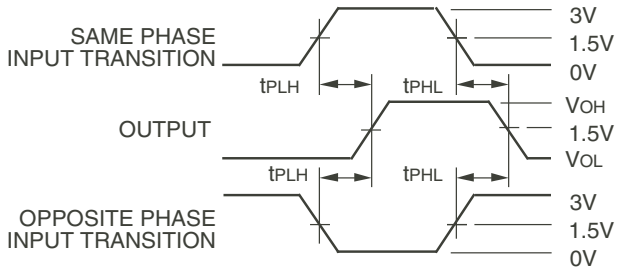
TEST CIRCUITS AND WAVEFORMS



Test Circuits for All Outputs



Set-up, Hold, and Release Times



Propagation Delay

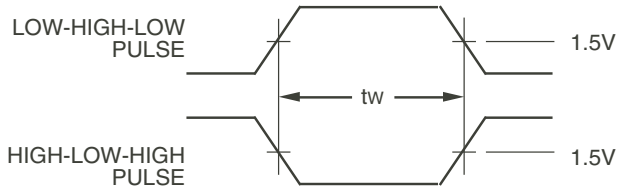
SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

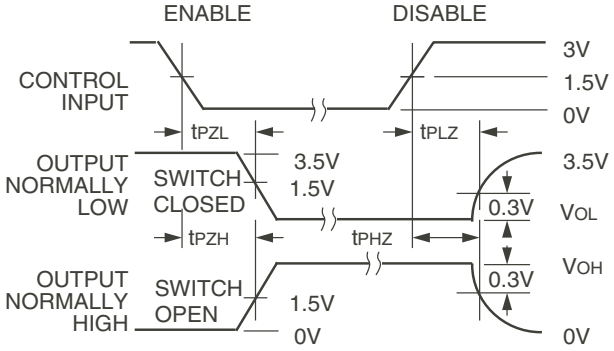
DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.



Pulse Width

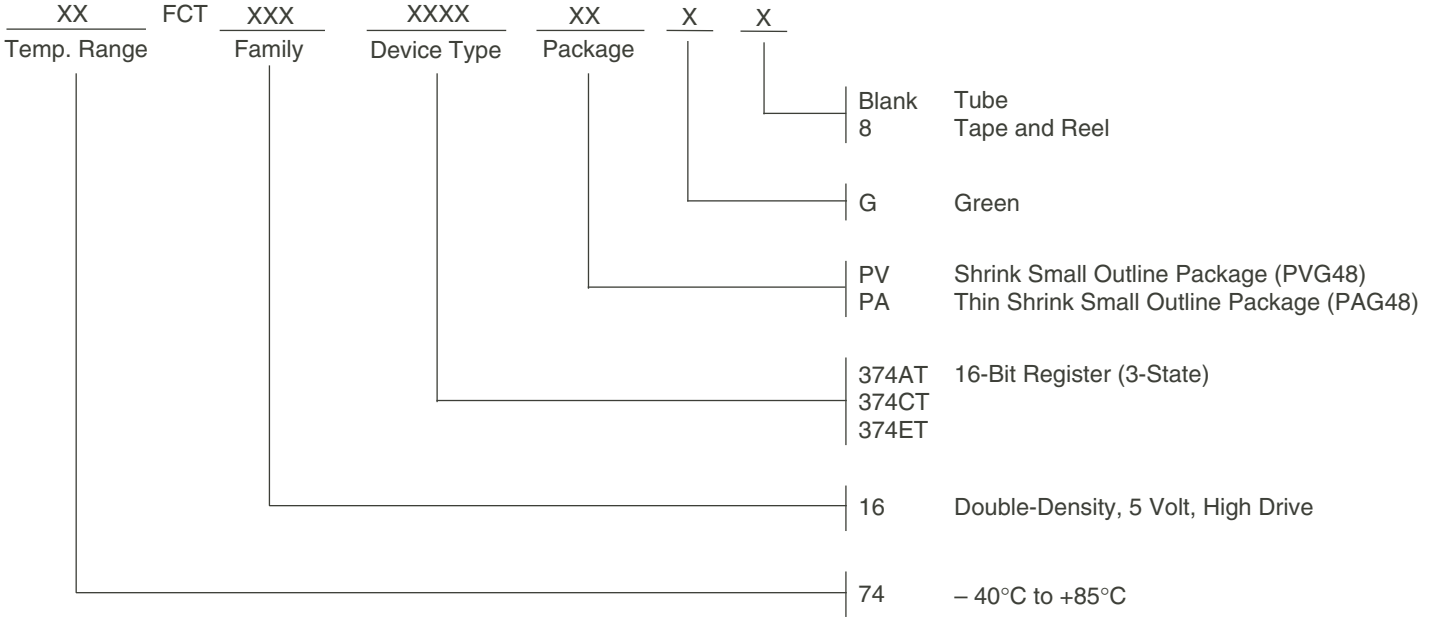


Enable and Disable Times

NOTES:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
2. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; t_F ≤ 2.5ns; t_R ≤ 2.5ns.

ORDERING INFORMATION



Orderable Part Information

Speed (ns)	Orderable Part ID	Pkg. Code	Pkg. Type	Temp. Grade
A	74FCT16374ATPAG	PAG48	TSSOP	I
	74FCT16374ATPAG8	PAG48	TSSOP	I
	74FCT16374ATPVG	PVG48	SSOP	I
	74FCT16374ATPVG8	PVG48	SSOP	I
C	74FCT16374CTPAG	PAG48	TSSOP	I
	74FCT16374CTPAG8	PAG48	TSSOP	I
	74FCT16374CTPVG	PVG48	SSOP	I
	74FCT16374CTPVG8	PVG48	SSOP	I
E	74FCT16374ETPAG	PAG48	TSSOP	I
	74FCT16374ETPAG8	PAG48	TSSOP	I
	74FCT16374ETPVG	PVG48	SSOP	I
	74FCT16374ETPVG8	PVG48	SSOP	I

Datasheet Document History

09/28/2009	Pg. 7	Updated the ordering information by removing the "IDT" notation and non RoHS part.
05/22/2018	Pg. 1, 2, 5, 7	Added table under pin configuration diagram with detailed package information. Updated the ordering information diagram by deleting 54FCT, MIL, Cerpack package and adding Tube, Tape and Reel. Added orderable part information table.
08/06/2018	Pg. 7	Corrected ordering information diagram symbol for "-"43
03/26/2019	Pg. 7	Typo in above text; should be -40 Not -43

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